

Product Information

Electronics

Sylgard[®] 577 Primerless Silicone Adhesive

FEATURES

- Flowable
- Heat cure
- High tensile strength
- Long working time after mixing
- UL 94 V-0 flammability rating

BENEFITS

- Rapid, versatile cure processing controlled by temperature
- Able to flow, fill or self-leveling after dispensing
- Long working time reduces need for equipment purging/clean-up
- Can be considered for uses requiring added flame resistance.

COMPOSITION

- Two-part
- 10 to 1 mix ratio
- Polydimethylsiloxane adhesive

Gray, flowable adhesive with high tensile strength and good flame resistance, MIL-PRF-23586F tested

APPLICATIONS

Sylgard[®] 577 Primerless Silicone Adhesive is suitable for:

- Sealing lids and housings
- Attaching baseplates
- Gasketing
- Connector sealing

TYPICAL PROPERTIES

Specification Writers: These values are not intended for use in preparing specifications. Please contact your local Dow Corning sales office or your Global Dow Corning Connection before writing specifications on this product.

Property	Unit	Result
One part or Two part	-	Two
Color	-	Gray
Viscosity (Base)	cP	121,500
	Pa-sec	121.5
Viscosity (Curing Agent)	cP	1300
	Pa-sec	1.3
Viscosity (Mixed)	cP	98,000
	Pa-sec	98
Working Time at 25 °C (Pot Life - hours)	hr	22
Heat Cure Time at 125 °C	minutes	60
Specific Gravity (Cured)	-	1.29
Durometer Shore A	-	60
Tensile Strength	psi	988
	MPa	6.8
	kg/cm ²	68
Elongation		224
Unprimed Adhesion - Lap Shear to Aluminum	psi	984
	MPa	6.8
	N/cm ²	678
Dielectric Strength	volts/mil	500
	kV/mm	19
Volume Resistivity	Ohm-cm	1.3 E+15
Dielectric Constant at 100 Hz	-	2.83
Dielectric Constant at 100 kHz	-	2.78
Dissipation Factor at 100 Hz	-	0.00065
Dissipation Factor at 100 kHz	-	<0.0004
UL Flammability Classification	NA	94 V-0
Mil Specification	NA	PRF-23586F

DESCRIPTION

Dow Corning[®] brand two-part heat cure (addition-curing) adhesives cure rate is rapidly accelerated with heat (see cure schedules in table) and an optimum cure schedule will balance processing performance and costs. For thicker sections or if voiding is observed the use of a 30-minute pre-cure at 70 °C (158 °F) or the use of an adhesive with low-void technology may reduce voids. Addition-cure silicones are formulated with all necessary ingredients for cure and there are no by-products generated during the cure process. Deep-section or confined cures are possible as cure reactions progress evenly throughout the material. These adhesives generally have long working times so users can enjoy the greatest manufacturing flexibility and reduce waste. *Dow Corning*[®] silicone adhesives retain their original physical and electrical properties over a broad range of operating conditions which enhance the reliability of and service life of electronic devices.

MIXING AND DE-AIRING

The 10:1 mix ratio these products are supplied in gives one latitude to tune the modulus and hardness for specific application needs and production lines. In most cases de-airing is not required. When thoroughly blended, the Part A and B liquid mixture should have a uniform appearance. The presence of light colored streaks or marbling indicates inadequate mixing and will result in incomplete cure. For fast-curing adhesives automated mix and dispense equipment should be utilized. In applications sensitive to air entrapment, de-airing with 28 to 30 inches Hg vacuum is required.

ADHESION

In general, increasing the cure temperature and/or cure time will improve the ultimate adhesion. *Dow Corning* silicone adhesives are specially formulated to provide unprimed adhesion to many reactive

metals, ceramics and glass, as well as to selected laminates, resins and plastics. However, good adhesion cannot be expected on non-reactive metal substrates or non-reactive plastic surfaces such as *Teflon*[®], polyethylene or polypropylene. Special surface treatments such as chemical etching or plasma treatment can sometimes provide a reactive surface and promote adhesion to these types of substrates. *Dow Corning*[®] brand Primers can be used to increase the chemical activity on difficult substrates. Poor adhesion may be experienced on plastic or rubber substrates that are highly plasticized, because the mobile plasticizers act as release agents. Small-scale laboratory evaluation of all substrates is recommended before production trials are made.

COMPATIBILITY

Certain materials, chemicals, curing agents and plasticizers can inhibit the cure of addition cure adhesives. Most notable of these include: Organotin and other organometallic compounds, Silicone rubber containing organotin catalyst, Sulfur, polysulfides, polysulfones or other sulfur containing materials, unsaturated hydrocarbon plasticizers, and some solder flux residues. If a substrate or material is questionable with respect to potentially causing inhibition of cure, it is recommended that a small scale compatibility test be run to ascertain suitability in a given application. The presence of liquid or uncured product at the interface between the questionable substrate and the cured gel indicates incompatibility and inhibition of cure.

PREPARING SURFACES

All surfaces should be thoroughly cleaned and/or degreased with *Dow Corning*[®] brand OS Fluids, naphtha, mineral spirits, methyl ethyl ketone (MEK) or other suitable solvent. Solvents such as acetone or isopropyl alcohol (IPA) do not tend to remove oils well, and any oils

remaining on the surface may interfere with adhesion. Light surface abrasion is recommended whenever possible, because it promotes good cleaning and increases the surface area for bonding. A final surface wipe with acetone or IPA is also useful. Some cleaning techniques may provide better results than others; users should determine the best techniques for their particular applications.

SUBSTRATE TESTING

Due to the wide variety of substrate types and differences in substrate surface conditions, general statements on adhesion and bond strength are impossible. To ensure maximum bond strength on a particular substrate, cohesive failure of the product in a lap shear or similar test is needed to ensure compatibility of the adhesive with the substrate being considered. Also, this test can be used to determine minimum cure time or to detect the presence of surface contaminants such as mold release agents, oils, greases and oxide films.

USEFUL TEMPERATURE RANGES

For most uses, silicone adhesives should be operational over a temperature range of -45 to 200 °C (-49 to 392 °F) for long periods of time. However, at both the low and high temperature ends of the spectrum, behavior of the materials and performance in particular applications can become more complex and require additional considerations. For low-temperature performance, thermal cycling to conditions such as -55 °C (-67 °F) may be possible but performance should be verified for your parts or assemblies. Factors that may influence performance are configuration and stress sensitivity of components, cooling rates and hold times, and prior temperature history. At the high-temperature end, the durability of the cured silicone elastomer is time and temperature dependent. As expected, the higher the temperature, the shorter

Dow Corning and *Sylgard* are registered trademarks of Dow Corning Corporation. *We help you invent the future* is a trademark of Dow Corning Corporation. XIAMETER is a registered trademark of Dow Corning Corporation. Teflon is a registered trademarks of E. I. du Pont de Nemours and Company or its affiliates © 2013 Dow Corning Corporation. All rights reserved.

the time the material will remain useable.

SOLVENT EXPOSURE

The silicone adhesive discussed in this literature is intended only to survive splash or intermittent exposures. It is not suited for continuous solvent or fuel exposure. Testing should be done to confirm performance of the adhesives under these conditions.

PACKAGING INFORMATION

Multiple packaging sizes are available for this product. Please contact your local distributor or Dow Corning representative for information on packaging size and availability.

USABLE LIFE AND STORAGE

The product should be stored in its original packaging with the cover tightly attached to avoid any contamination. Store in accordance with any special instructions listed on the product label. The product should be used by its Use Before date as indicated on the product label.

HANDLING PRECAUTIONS PRODUCT SAFETY INFORMATION REQUIRED FOR SAFE USE IS NOT INCLUDED IN THIS DOCUMENT. BEFORE HANDLING, READ PRODUCT AND MATERIAL SAFETY DATA SHEETS AND CONTAINER LABELS FOR SAFE USE, PHYSICAL AND HEALTH HAZARD INFORMATION. THE MATERIAL SAFETY DATA SHEET IS AVAILABLE ON THE DOW CORNING WEB SITE AT DOWCORNING.COM, OR FROM YOUR DOW CORNING REPRESENTATIVE, OR DISTRIBUTOR, OR BY CALLING YOUR GLOBAL DOW CORNING CONNECTION.

LIMITATIONS

This product is neither tested nor represented as suitable for medical or pharmaceutical uses.

HEALTH AND ENVIRONMENTAL INFORMATION

To support Customers in their product safety needs, Dow Corning has an extensive Product Stewardship organization and a team of Product Safety and Regulatory Compliance (PS&RC) specialists available in each area.

For further information, please see our Web site, dowcorning.com or consult your local Dow Corning representative.

LIMITED WARRANTY INFORMATION – PLEASE READ CAREFULLY

The information contained herein is offered in good faith and is believed to be accurate. However, because conditions and methods of use of our products are beyond our control, this information should not be used in substitution for customer's tests to ensure that our products are safe, effective, and fully satisfactory for the intended end use. Suggestions of use shall not be taken as inducements to infringe any patent.

Dow Corning's sole warranty is that our products will meet the sales specifications in effect at the time of shipment.

Your exclusive remedy for breach of such warranty is limited to refund of purchase price or replacement of any product shown to be other than as warranted.

DOW CORNING SPECIFICALLY DISCLAIMS ANY OTHER EXPRESS OR IMPLIED WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE OR MERCHANTABILITY.

DOW CORNING DISCLAIMS LIABILITY FOR ANY INCIDENTAL OR CONSEQUENTIAL DAMAGES.

FOR MORE INFORMATION

To learn more about these and other products available from Dow Corning, please visit the Dow Corning Electronics Web site at dowcorning.com/electronics.

We help you invent the future.™

dowcorning.com